

Multilayer Band Pass Filter

For 5GHz W-LAN

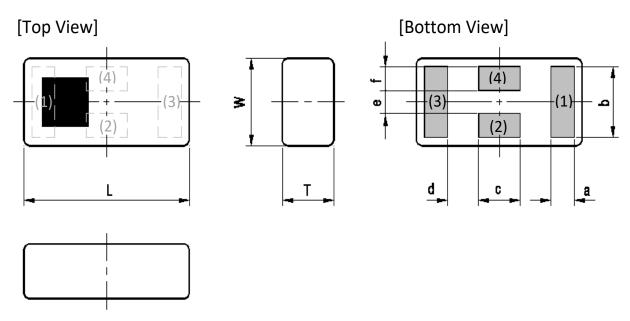
DEA Series 1.6x0.8mm [EIA 0603] TYPE

P/N: **DEA165538BT-2208F1** 



# **DEA165538BT-2208F1**

## SHAPES AND DIMENSIONS



Dimensions (mm)

L	W	T	а	b	С	d	е	f
1.60	0.80	0.65	0.23	0.65	0.40	0.30	0.21	0.22
+/-0.15	+/-0.10	Max	+/-0.05	+/-0.05	+/-0.05	+/-0.05	+/-0.05	+/-0.05

**Terminal functions** 

(1)	Input Port					
(2)	GND					
(3)	Output Port					
(4)	GND					

## TERMINATION FINISH

Material
Ag



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## ELECTRICAL CHARACTERISTICS

(Measurement)

Parameter	Frequency (MHz			TDK Spec		
Faranteter	Freque	псу	(IVIITZ)	Min.	Тур.	Max.
Insertion Loss (dB)	5150	to	5925	•	0.68	0.95
Insertion Loss (dB)	5150	to	5925	-	-	1.15
( -40 to +90 °C )		to				
VSWR	5150	to	5925	ı	1.2	1.6
Attenuation (dB)	699	to	960	45	56.1	-
	960	to	1710	40	44.9	-
	1710	to	2690	37	38.5	-
	2690	to	3550	20	38.5	-
	3400	to	3600	32	38.7	-
	3600	to	3800	22	28.2	-
	3550	to	4000	12	20.8	-
	4	400	)	6.15	9.0	-
	4000	to	4500	-	6.5	-
	6500	to	7000	ı	1.7	-
	6850	to	7000	-	6.3	-
	7000	to	7400	3	9.2	-
	7400	to	9750	10	16.7	-
	9750	to	10300	20	59.7	-
	10300	to	12750	35	46.7	-
	15450	to	17550	35	44.9	-
Characteristic Impedance (ohm)				50	(Nomi	nal)

Ta = +25 + /-5°C

## MAXIMUM RATINGS

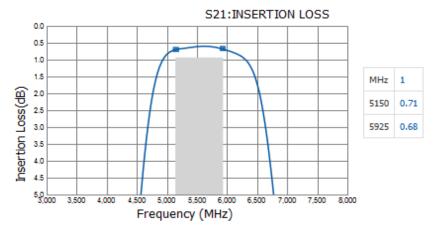
Parameter	TDK Spec	Conditions	
Operating temperature (°C)	–40 to +90 °C		
Storage temperature (°C)		–40 to +90 °C	
Power Handling (W) *1	Frequency (MHz)		
	5150 to 5925	2	
Human Body Model: HBM	@Each Port (V)	+/-1000	100pF / 1500ohm
Machine Model: MM	@Each Port (V)	+/-150	200pF / 0ohm
Charged Device Model : CDM	@Each Port (V)	+/-500	Humidity: 60%RH max

\*1: Refer to 3GPP TS 38.101-1 V15.2.0

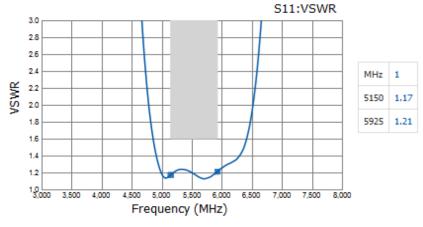
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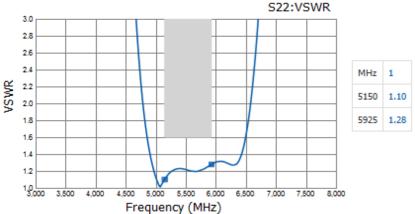
## FREQUENCY CHARACTERISTICS

#### **Insertion Loss**



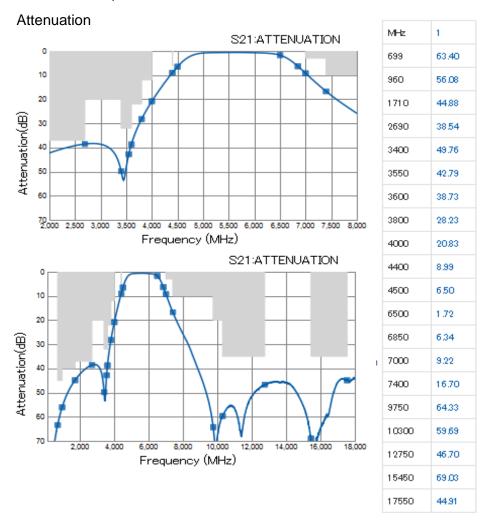
#### **VSWR**





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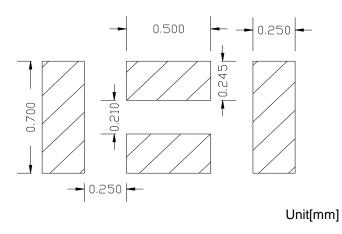
## FREQUENCY CHARACTERISTICS

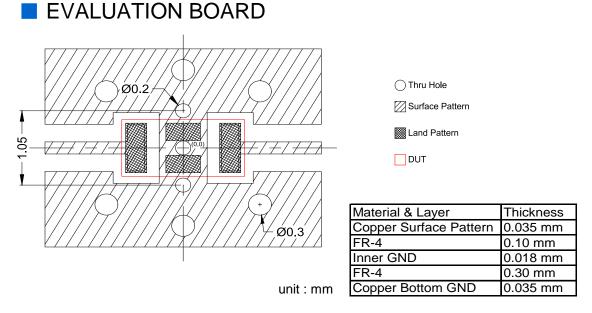




#### **DEA165538BT-2208F1**

#### RECOMMENDED LAND PATTERN





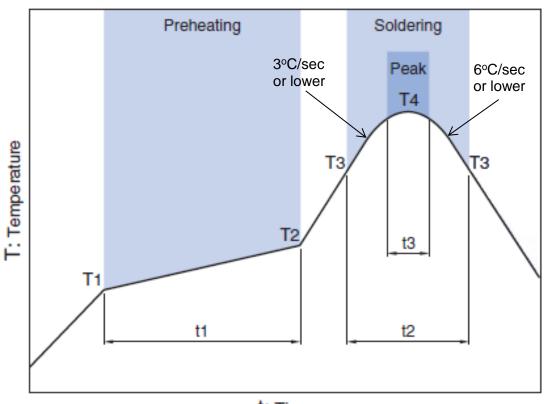
- \* Line width should be designed to match 50 ohm characteristic impedance depending on PCB material and thickness.
- \*\* The position of the throuh hole which have possibility of influence to the prerformance are indicated by dimension line.

#### ENVIRONMENT INFORMATION

RoHS Statement RoHS Compliance

## **DEA165538BT-2208F1**

## RECOMMENDED REFLOW PROFILE



t: Time

	Drobe	eating	Soldering						
	FIEII	aung	Critical zon	e (T3 to T4)	Peak				
Tei	Temp. Time		Temp.	Time	Temp. Time				
T1 T2 t1		Т3	t2	T4	t3 *				
150°C	200°C	60 to 120sec	217°C	60 to 120sec	240 to 260°C	30 sec Max			

\* t3 : Time within 5°C of actual peak temperature

The maximum number of reflow is 3.

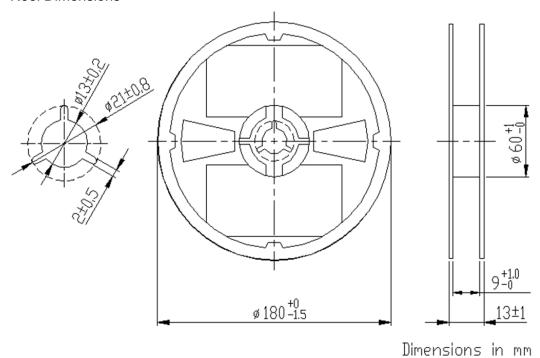
Note: Lead free solder is recommended.

Recommended solder is Sn-3.0Ag-0.5Cu. (M705 by Senju Metal Industry)

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## PACKAGING STYLE

#### **Reel Dimensions**



Carrier Tape

Sprocket hole

Loading Direction

H
G
F

#### Dimensions (mm)

Α	В	C	D	Ε	F	G	Н	J	K	t
0.97	1.8	8.0	3.5	1.75	4.0	2.0	4.0	1.5	0.8	0.25
+/-0.05	+/-0.05	+/-0.2	+/-0.05	+/-0.1	+/-0.1	+/-0.05	+/-0.1	+0.1/-0	MAX	+/-0.05

STANDARD PACKAGE QUANTITY
( pieces/reel )
4,000



#### REMINDERS FOR USING THESE PRODUCTS

Before using these products, be sure to request the delivery specifications.

#### SAFETY REMINDERS

Please pay sufficient attention to the warnings for safe designing when using these products.

# **↑** REMINDERS

The products listed on this specification sheet are intended for use in general electronic equipment (AV equipment, telecommunications equipment, home appliances, amusement equipment, computer equipment, personal equipment, office equipment, measurement equipment, industrial robots) under a normal operation and use condition.

The products are not designed or warranted to meet the requirements of the applications listed below, whose performance and/or quality require a more stringent level of safety or reliability, or whose failure, malfunction or trouble could cause serious damage to society, person or property. Please understand that we are not responsible for any damage or liability caused by use of the products in any of the applications below or for any other use exceeding the range or conditions set forth in this specification sheet.

- 1. Aerospace/Aviation equipment
- 2. Transportation equipment (cars, electric trains, ships, etc.)
- 3. Medical equipment
- 4. Power-generation control equipment
- 5. Atomic energy-related equipment
- 6. Seabed equipment
- 7. Transportation control equipment
- 8. Public information-processing equipment
- 9. Military equipment
- 10. Electric heating apparatus, burning equipment
- 11. Disaster prevention/crime prevention equipment
- 12. Safety equipment
- 13. Other applications that are not considered general-purpose applications

When using this product in general-purpose applications, you are kindly requested to take into consideration securing protection circuit/equipment or providing backup circuits, etc., to ensure higher safety.